

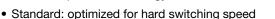
Dual INT-A-PAK Low Profile "Half Bridge" (Standard Speed IGBT), 300 A



PRIMARY CHARACTERISTICS						
V _{CES}	600 V					
I _C DC at T _C = 100 °C	300 A					
V _{CE(on)} (typical) at 300 A, 25 °C	1.15 V					
Speed	DC to 1 kHz					
Package	Dual INT-A-PAK low profile					
Circuit configuration	Half bridge					

FEATURES







- Low V_{CE(on)}
- Square RBSOA
- Gen 4 FRED Pt® dices technology
- Industry standard package
- Al₂O₃ DBC
- UL approved file E78996



- · Designed for industrial level
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Increased operating efficiency
- · Performance optimized as output inverter stage for TIG welding machines
- · Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS						
PARAMETER SYMBOL		TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		600	V		
Continuous collector current	Ic (1)	T _C = 25 °C	466			
Continuous collector current	IC (''	T _C = 80 °C	349			
Pulsed collector current	I _{CM}	$T_C = 175 ^{\circ}\text{C}, t_p = 6 \text{ms}, V_{GE} = 15 \text{V}$	1500	_		
Clamped inductive load current	I _{LM}		700	Α		
District of the soll of the so		T _C = 25 °C	260	1		
Diode continuous forward current	I _F	T _C = 80 °C	192			
Gate to emitter voltage	V_{GE}		± 20	V		
Maximum navvar dissination (ICDT)	В	T _C = 25 °C	882	w		
Maximum power dissipation (IGBT)	P_{D}	T _C = 80 °C	559			
Maximum navvar dissination (diada)	В	T _C = 25 °C	441	14/		
Maximum power dissipation (diode)	P_{D}	T _C = 80 °C	279	W		
RMS isolation voltage	V _{ISOL}	Any terminal to case (V _{RMS} t = 1 s, T _J = 25 °C)	3500	V		

Note

⁽¹⁾ Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, I_{C} = 800 \mu\text{A}$	600	-	-	
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 300 A	-	1.15	1.47	v
		$V_{GE} = 15 \text{ V}, I_{C} = 300 \text{ A}, T_{J} = 125 \text{ °C}$	-	1.16	-	v
Gate threshold voltage	$V_{GE(th)} \qquad V_{CE} = V_{GE}, I_C = 4 \text{ mA} $ 3.8		3.8	5.0	6.3	i
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$	-	1.2	200	μA
Collector to entitter leakage current		V _{GE} = 0 V, V _{CE} = 600 V, T _J = 125 °C	-	380	-	μΑ
Diode forward voltage drop	V _{FM}	I _{FM} = 300 A	-	1.56	2.02	V
Diode forward voltage drop		I _{FM} = 300 A, T _J = 125 °C	-	1.45	-	V
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg		-	1863	-	
Gate-to-emitter charge (turn-on)	Q _{ge}	$I_C = 75 \text{ A}, V_{CC} = 520 \text{ V}, V_{GE} = 15 \text{ V}$	-	296	-	nC
Gate-to-collector charge (turn-on)	Q _{gc}		-	540	-	
Turn-on switching loss	E _{on}		-	2.1	-	
Turn-off switching loss	E _{off}	$I_C = 300$ A, $V_{CC} = 300$ V, $V_{GE} = 15$ V, $R_a = 1.5$ Ω, $L = 500$ μH, $T_J = 25$ °C	-	13.9	-	
Total switching loss	E _{tot}	1 ig = 1.0 12, E = 000 pi i, i j = 20 0	-	16	-	m l
Turn-on switching loss	E _{on}		-	2	-	mJ
Turn-off switching loss	E _{off}		-	20	-	
Total switching loss	E _{tot}		-	22	-	
Turn-on delay time	t _{d(on)}	$I_C = 300$ A, $V_{CC} = 300$ V, $V_{GE} = 15$ V, $R_0 = 1.5$ Ω, $L = 500$ μH, $T_J = 125$ °C	-	19	-	
Rise time	t _r	1 1g = 1.0 12, E = 000 pi 1, 1g = 120 0	-	75	-	ns
Turn-off delay time	t _{d(off)}		-	419	-	115
Fall time	t _f		-	194	-	
Reverse bias safe operating area	RBSOA	$T_J = 175$ °C, $I_C = 700$ A, $R_g = 1.5 \Omega$, $V_{GE} = +15$ V/0 V, $V_{CC} = 300$ V, $V_p = 600$ V	Fullsquare			
Diode reverse recovery time	t _{rr}		-	152	-	ns
Diode peak reverse current	I _{rr}	$I_F = 50 \text{ A}, \text{ d}I_F/\text{dt} = 500 \text{ A/}\mu\text{s}, \text{ V}_{CC} = 200 \text{ V}, \\ T_{.1} = 25 ^{\circ}\text{C}$	-	24	-	Α
Diode recovery charge	Q _{rr}	1,5 = 2.5	-	1.81	-	μC
Diode reverse recovery time	t _{rr}	1 50 A 31 /31 500 A/ - V 300 V	-	201	-	ns
Diode peak reverse current	I _{rr}	$I_F = 50 \text{ A}, dI_F/dt = 500 \text{ A/}\mu\text{s}, V_{CC} = 200 \text{ V}, $ $T_{.1} = 125 ^{\circ}\text{C}$	-	39	-	Α
Diode recovery charge	Q _{rr}	.5 .25 0	-	3.94	-	μC

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER			SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction and storage temperature range		T _J , T _{Stg}	-40	-	175	°C		
Junction to case per leg		IGBT	R _{thJC}	-	-	0.17	°C/W	
		Diode		-	-	0.34		
Case to sink per module			R _{thCS}	-	0.05	-		
Mounting torque	case to heatsink: M6 screw			4	-	6	Nima	
	case to terminal 1, 2, 3: M5 screw			2	-	5	Nm	
Weight				-	270	-	g	

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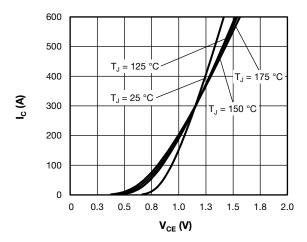


Fig. 1 - Typical Trench IGBT Output Characteristics, $V_{GE} = 15 \text{ V}$

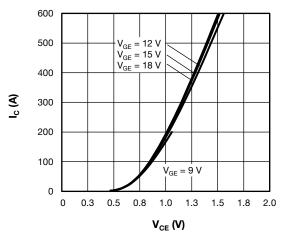


Fig. 2 - Typical Trench IGBT Output Characteristics, $\rm T_{J} = 125\ ^{\circ}C$

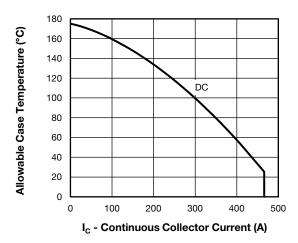


Fig. 3 - Maximum Trench IGBT Continuous Collector Current vs.

Case Temperature

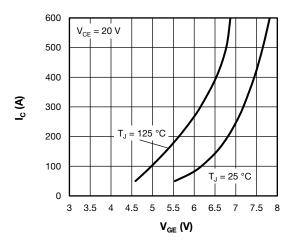


Fig. 4 - Typical Trench IGBT Transfer Characteristics

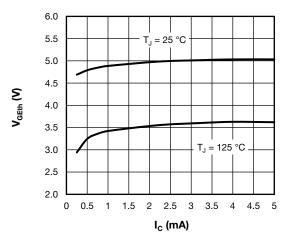


Fig. 5 - Typical Trench IGBT Gate Threshold Voltage

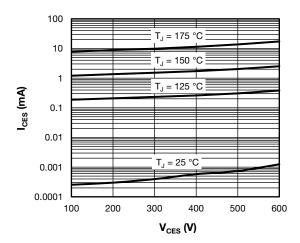


Fig. 6 - Typical trench IGBT Zero Gate Voltage Collector Current

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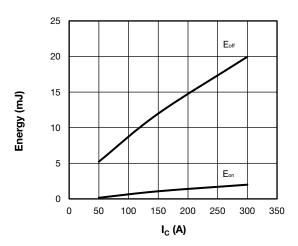


Fig. 7 - Typical Trench IGBT Energy Loss vs. I $_{C)},$ (with Antiparallel Diode), T $_{J}$ = 125 °C, V $_{CC}$ = 300 V, R $_{g}$ = 1.5 $\Omega,$ V $_{GE}$ = +15 V/-15 V, L = 500 μH

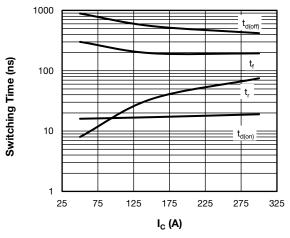


Fig. 8 - Typical Trench IGBT Switching Time vs. I_{C,} (with Antiparallel Diode), T_J = 125 °C, V_{CC} = 300 V, R_g = 1.5 Ω , V_{GE} = +15 V/-15 V, L = 500 μ H

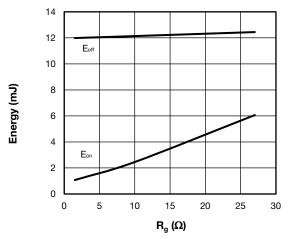


Fig. 9 - Typical Trench IGBT Energy Loss vs. R_g (with Antiparallel Diode), T_J = 125 °C, V_{CC} = 300 V, I_C = 300 A, V_{GE} = +15 V/-15 V, L = 500 μH

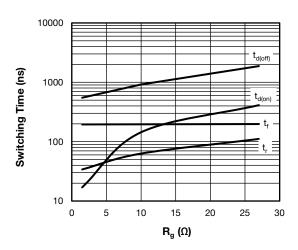


Fig. 10 - Typical Trench IGBT Switching Time vs. R_g (with Antiparallel Diode), T_J = 125 °C, V_{CC} = 300 V, I_C = 300 Å, V_{GE} = +15 V/-15 V, L = 500 μH

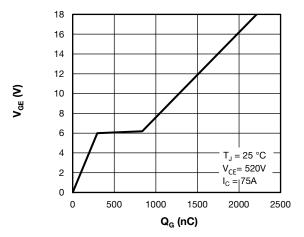


Fig. 11 - Typical Trench IGBT Gate Charge vs. Gate to Emitter Voltage

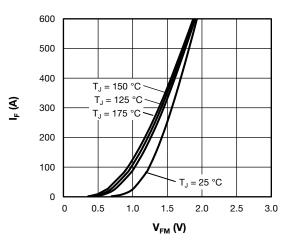


Fig. 12 - Typical Antiparallel Diode Forward Characteristics

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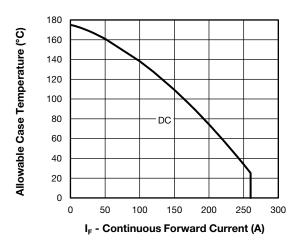


Fig. 13 - Maximum Antiparallel Diode Continuous Forward Current vs. Case Temperature

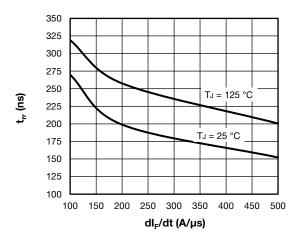


Fig. 14 - Typical Antiparallel Diode Reverse Recovery Time vs. dI_F/dt , $I_F = 50$ A, $V_{CC} = 200$ V

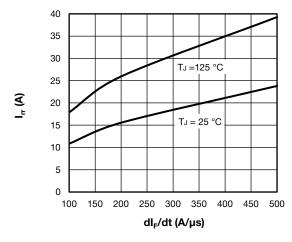


Fig. 15 - Typical Antiparallel Diode Reverse Recovery Current vs. dI_F/dt , $I_F = 50$ A, $V_{CC} = 200$ V

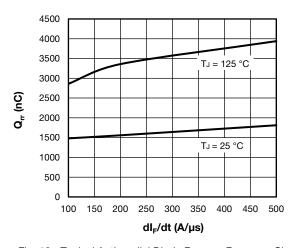


Fig. 16 - Typical Antiparallel Diode Reverse Recovery Charge vs. dI_F/dt, I_F = 50 A, $V_{\rm CC}$ = 200 V

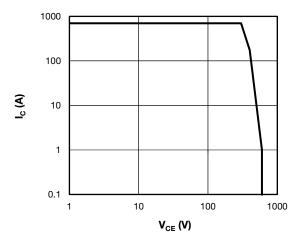


Fig. 17 - Trench IGBT Reverse BIAS SOA T_J = 175 °C, I_C = 700 A, R_g = 1.5 $\Omega,\,V_{GE}$ = +15 V/0 V, V_{CC} = 300 V, V_p = 600 V

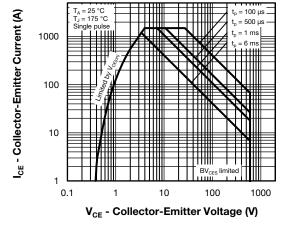


Fig. 18 - Trench IGBT Safe Operating Area



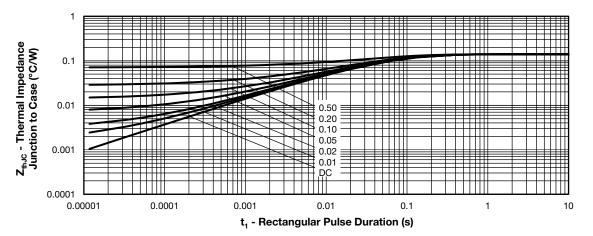


Fig. 19 - Maximum Trencj IGBT Thermal Impedance Z_{thJC} Characteristics (IGBT)

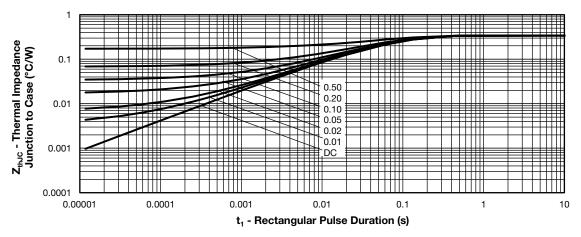


Fig. 20 - Maximum Antiparallel Diode Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code G T 300 T D 60 S

1 2 3 4 5 6 7

1 - Insulated gate bipolar transistor (IGBT)

2 - T = Trench IGBT technology

3 - Current rating (300 = 300 A)

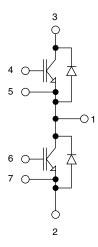
- Circuit configuration (T = half bridge)

Package indicator (D = dual INT-A-PAK low profile)

6 - Voltage rating (60 = 600 V)

Speed / type (S = standard speed IGBT)

CIRCUIT CONFIGURATION

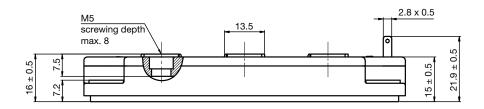


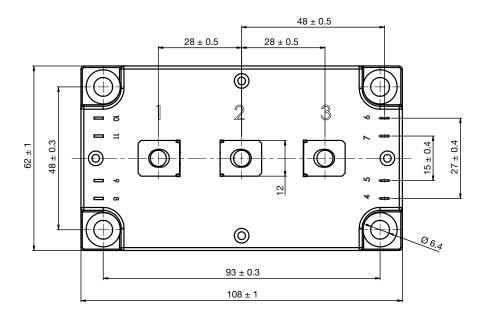
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95435			



Dual INT-A-PAK Low Profile

DIMENSIONS in millimeters







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